

On-Die Decoupling Model Improvements for IBIS Power Aware Models

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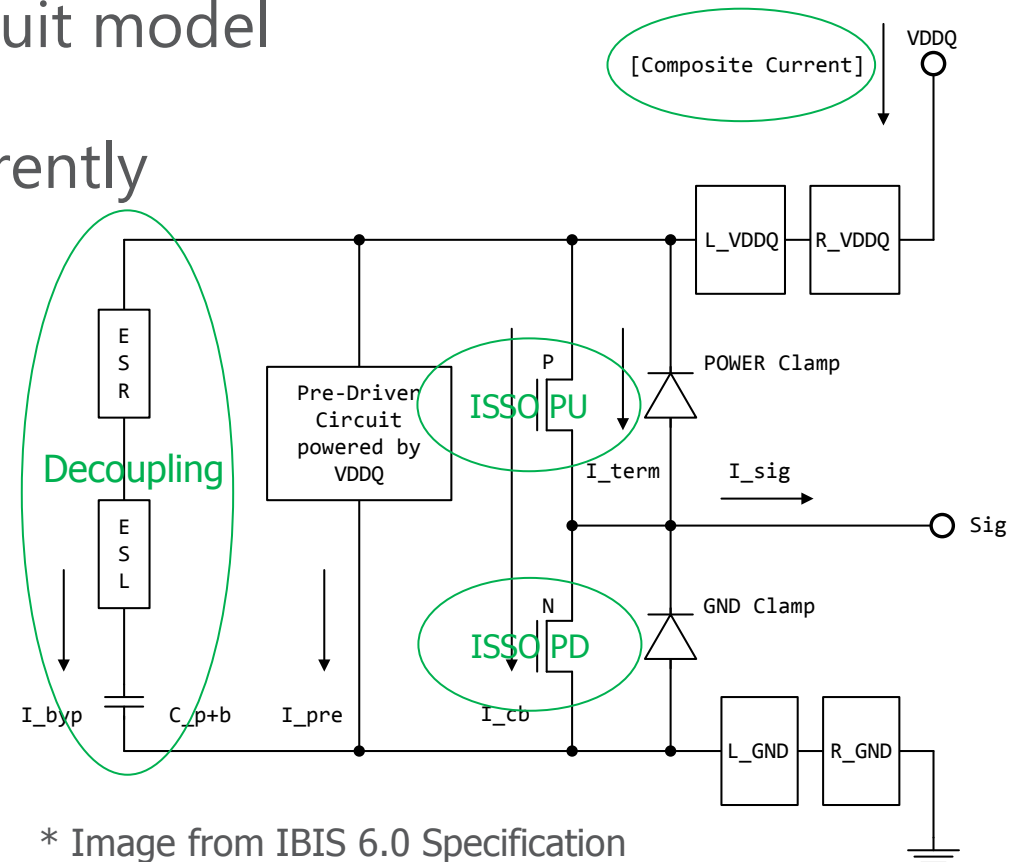
Outline

- IBIS Power-aware modeling overview
- On-die Decoupling models
- Multi-port Decoupling models
- Example Simulations
- Conclusions

IBIS Power-aware Modeling Overview

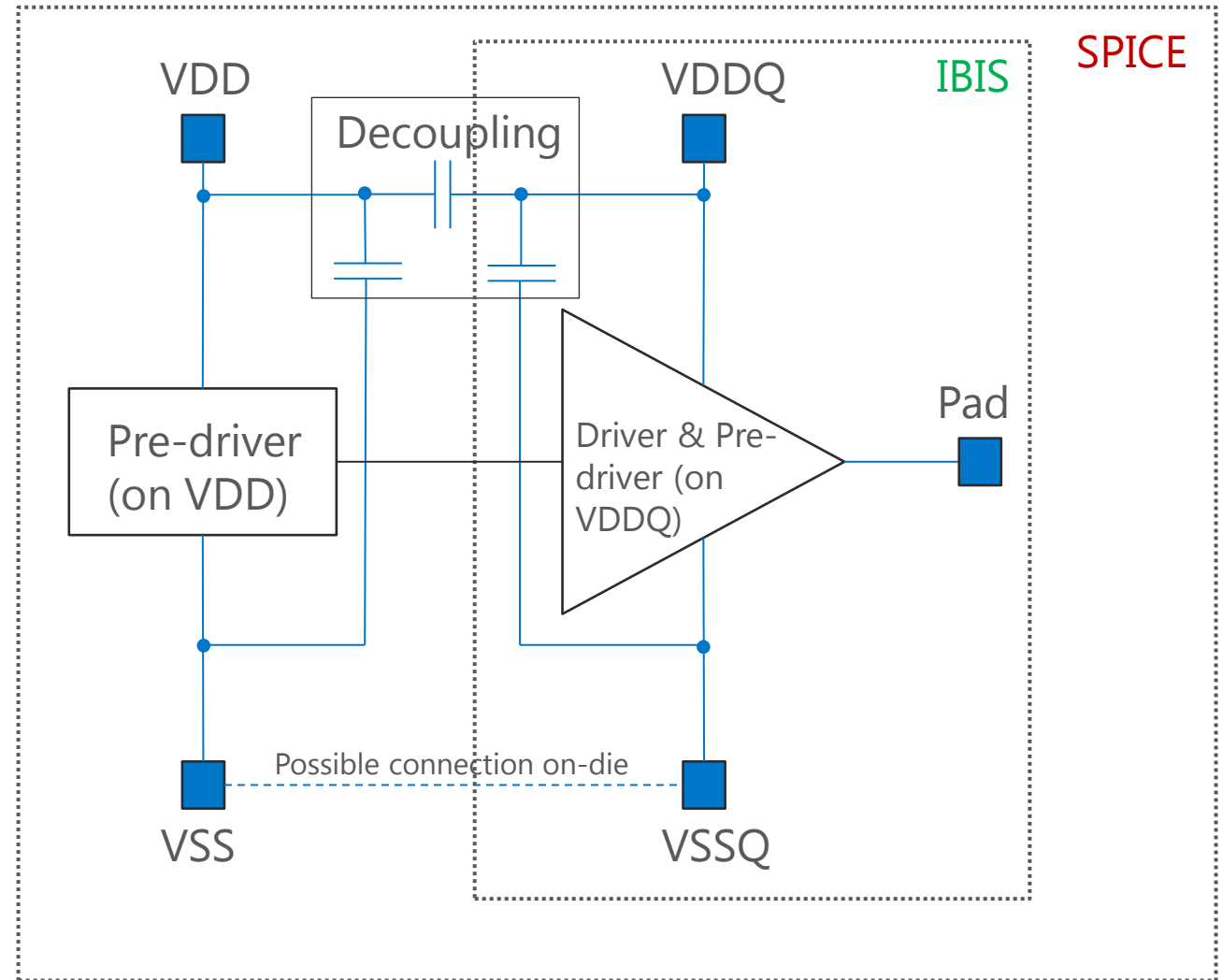
- Power Integrity modeling uses [Composite Current], [ISSO PU], [ISSO PD] and an IBIS-ISS on-die decoupling circuit model
- Decoupling model external to IBIS currently

<code>I_byp</code>	- Bypass current
<code>I_pre</code>	- Pre-Driver current
<code>I_cb</code>	- Crow-bar current
<code>I_term</code>	- Termination current (optional)
<code>L_VDDQ</code>	- On-die inductance of I/O Power
<code>R_VDDQ</code>	- On-die resistance of I/O Power
<code>L_GND</code>	- On-die inductance of Ground
<code>R_GND</code>	- On-die resistance of Ground
<code>C_p+b</code>	- Bypass + Parasitic Capacitance
<code>ESR</code>	- Equivalent Series Resistance for on-die Decap
<code>ESL</code>	- Equivalent Series Inductance for on-die Decap



On-die Decoupling Models

- SPICE model may have pre-driver circuits on separate power supplies
- May be one common ground on-die
- Decoupling model could include VDDQ, VSSQ, VDD, VSS
- What is needed for IBIS to correlate with SPICE?



Multi-port Decoupling Models

- Decoupling circuits may contain proprietary modeling equations or process data
- A non-proprietary model can be an S-parameter or a broadband SPICE macromodel (of the S-parameter characterization)
- S-parameter port options
 - 1-port: VDDQ with VSSQ reference
 - 2-port: VDDQ, VSSQ, with 0 reference
 - 3 or [4] port: VDDQ, VSSQ, VDD, [VSS], with 0 reference

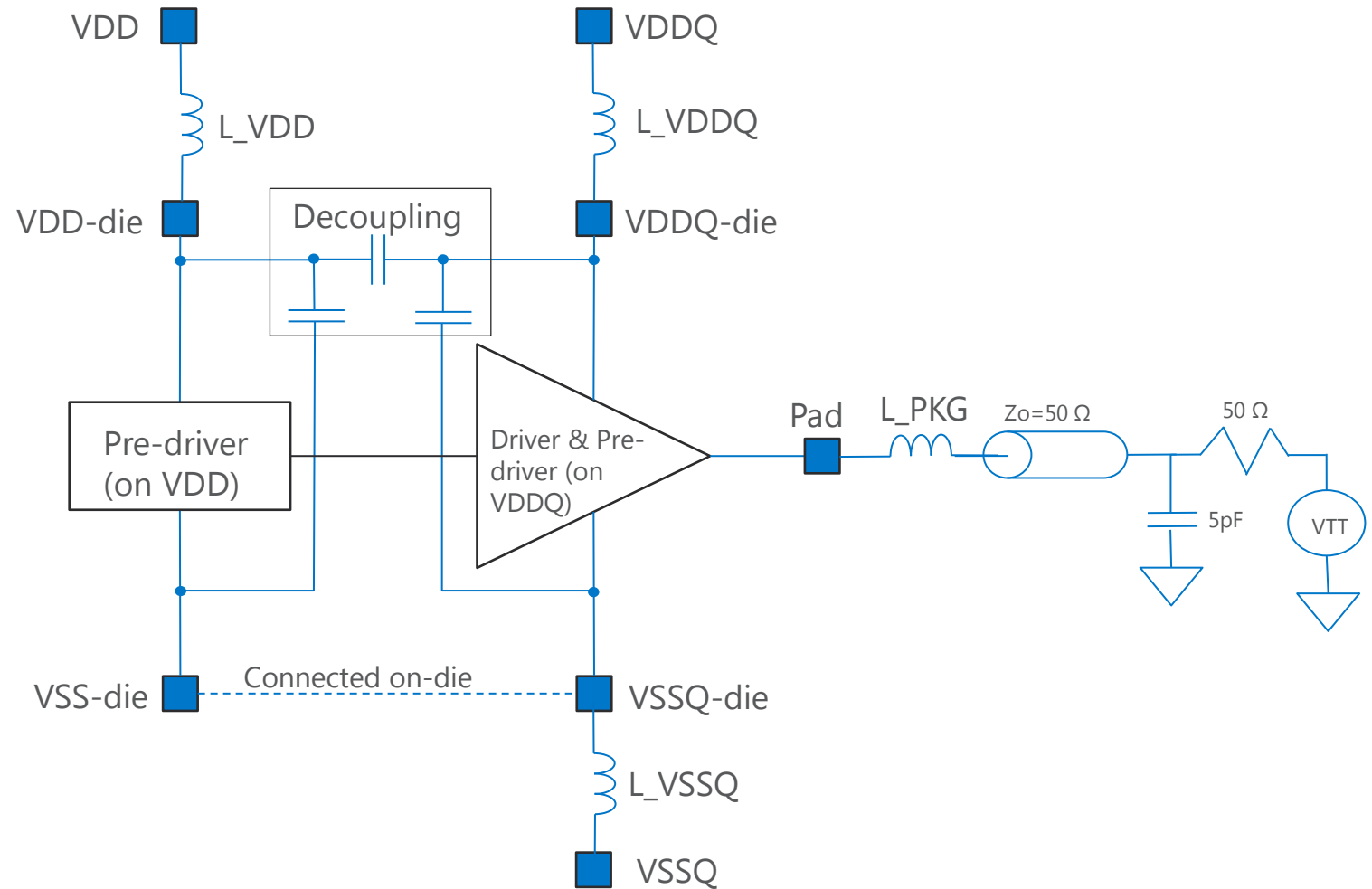
SPICE Setup Examples for Decoupling Model Creation

- Buffer Instance in Hi-Z state:
 - Xbuff ... VDDQ_die VSSQ_die ... Buffer_name
- Port Definition:
 - Single Port
 - P1 VDDQ_die VSSQ_die port=1 Z0=50 DC VDDQ
 - Multi Port
 - P1 VDDQ_die 0 port=1 Z0=50 DC VDDQ
 - P2 VSSQ_die 0 port=2 Z0=50 DC 0
- AC Analysis
 - .lin sparcalc=1 filename='s_model.sNp' format=touchstone dataformat=ma freqdigit=10 spardigit=10
 - .ac dec 100 1 10e12

Example Simulation 1 – Ideal VDD

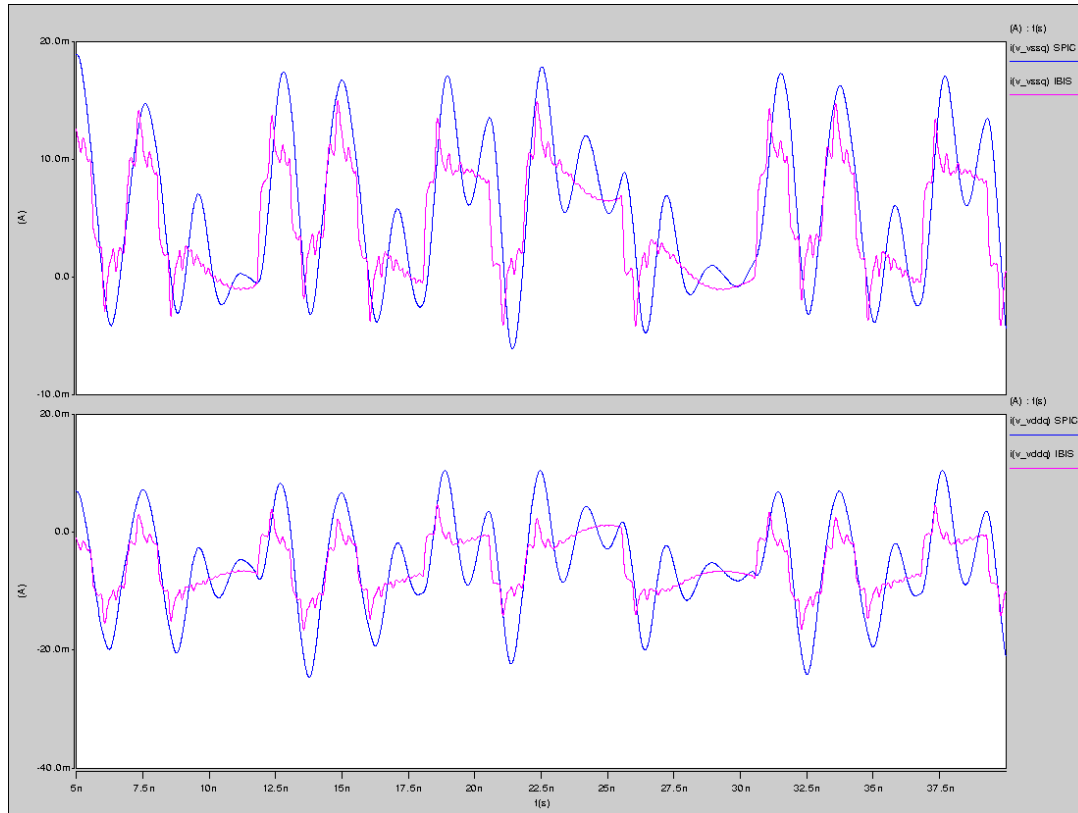
Comparing Transistor-level and IBIS Model in SPICE

- $L_{VDD}=0$ (short)
- $L_{VDDQ}=1.25\text{nH}$
- $L_{VSSQ}=1.25\text{nH}$
- $L_{PKG}=1.25\text{nH}$

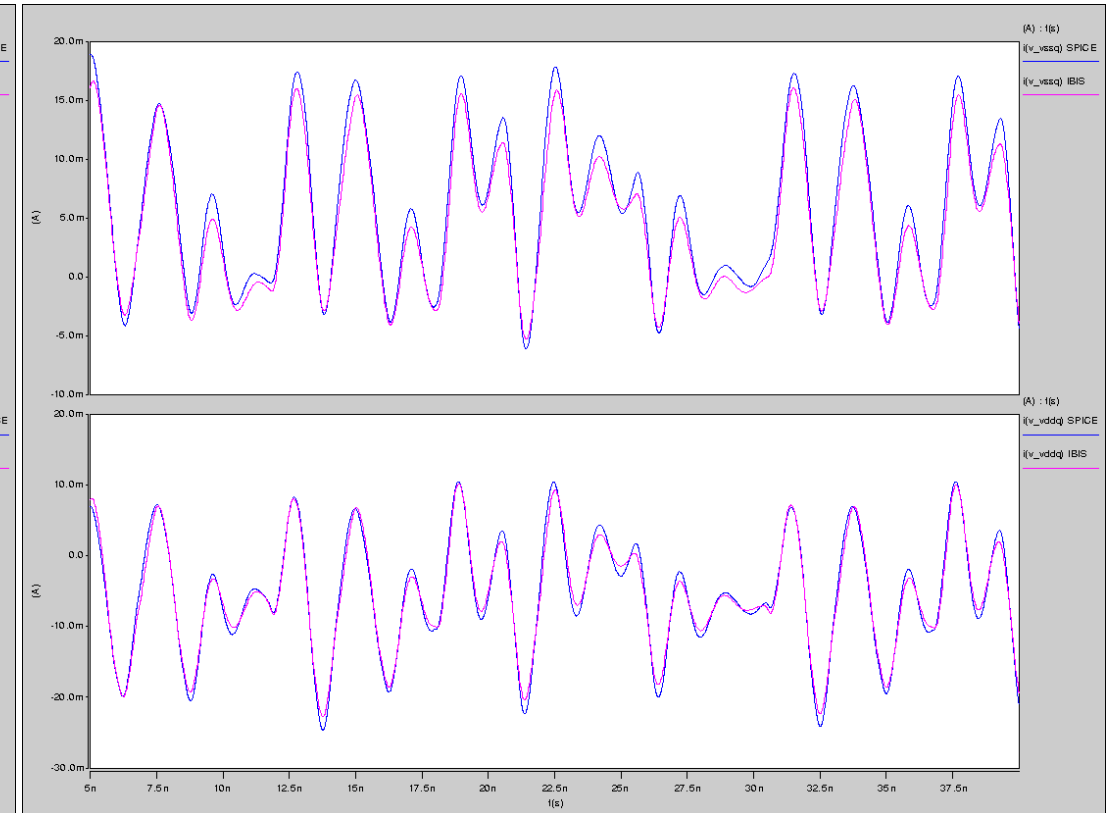


1-Port vs. 2-Port Models, I(VSSQ) and I(VDDQ)

1-Port

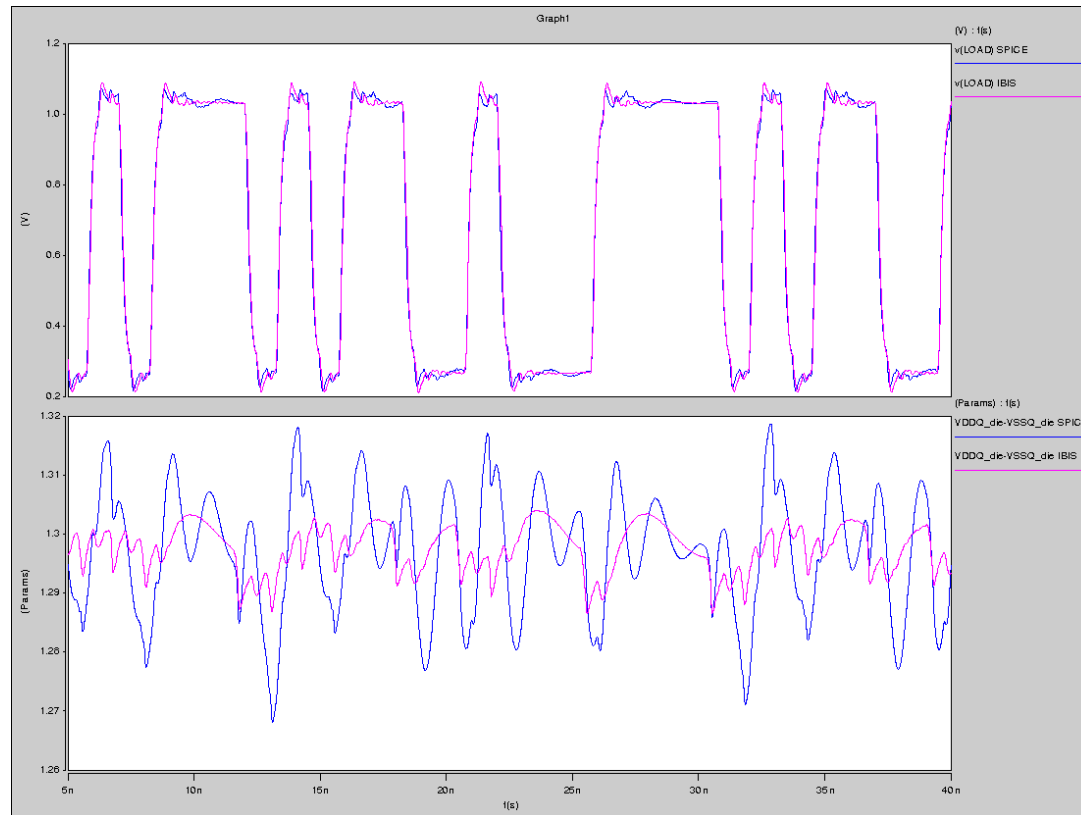


2-Port

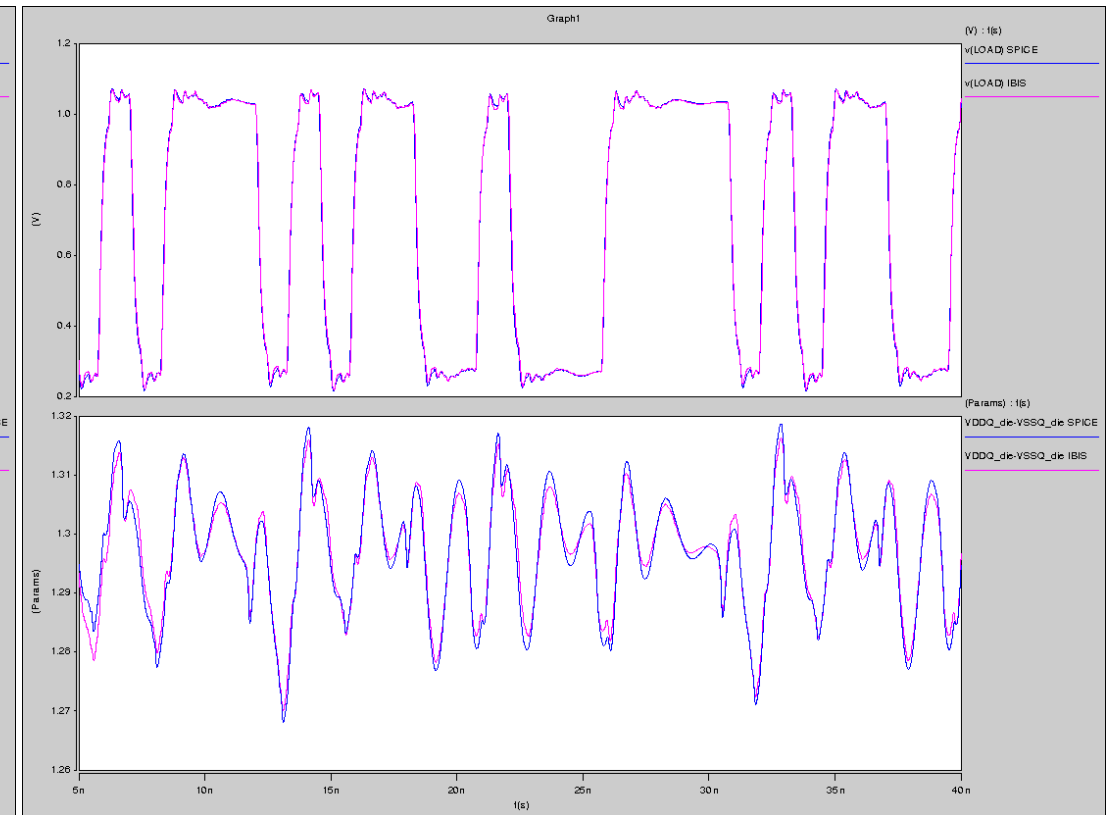


$V(\text{LOAD})$ and $V(\text{VDDQ_die}) - V(\text{VSSQ_die})$

1-Port



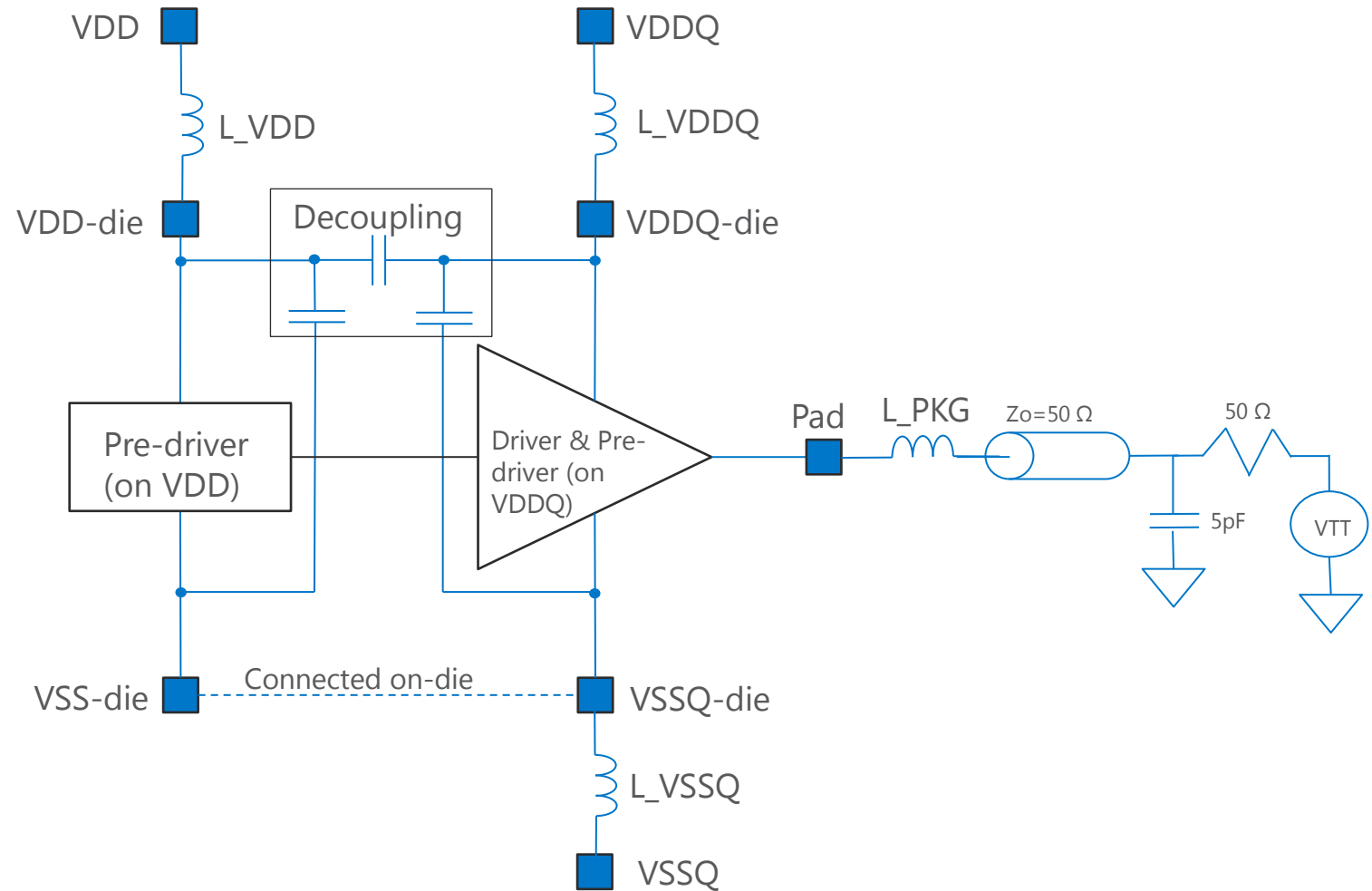
2-Port



Example Simulation 2 – Non-ideal VDD

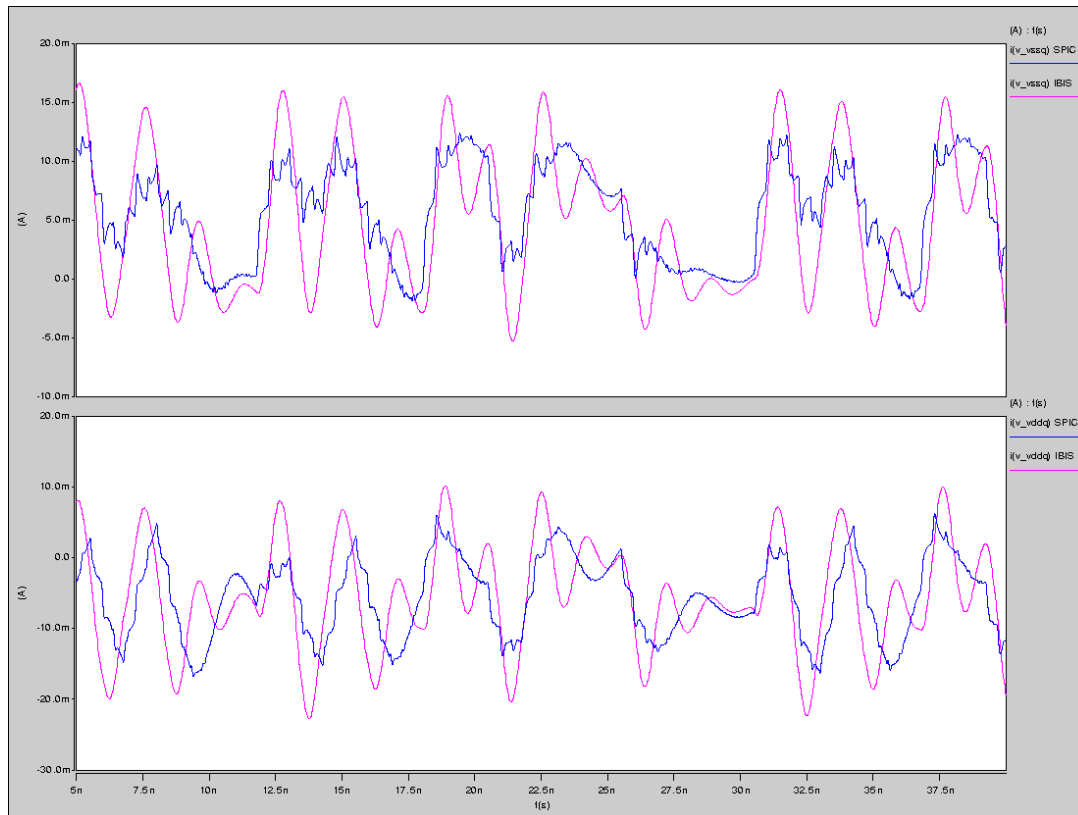
Comparing Transistor-level and IBIS Model in SPICE

- $L_{VDD} = 1.25\text{nH}$
- $L_{VDDQ} = 1.25\text{nH}$
- $L_{VSSQ} = 1.25\text{nH}$
- $L_{PKG} = 1.25\text{nH}$

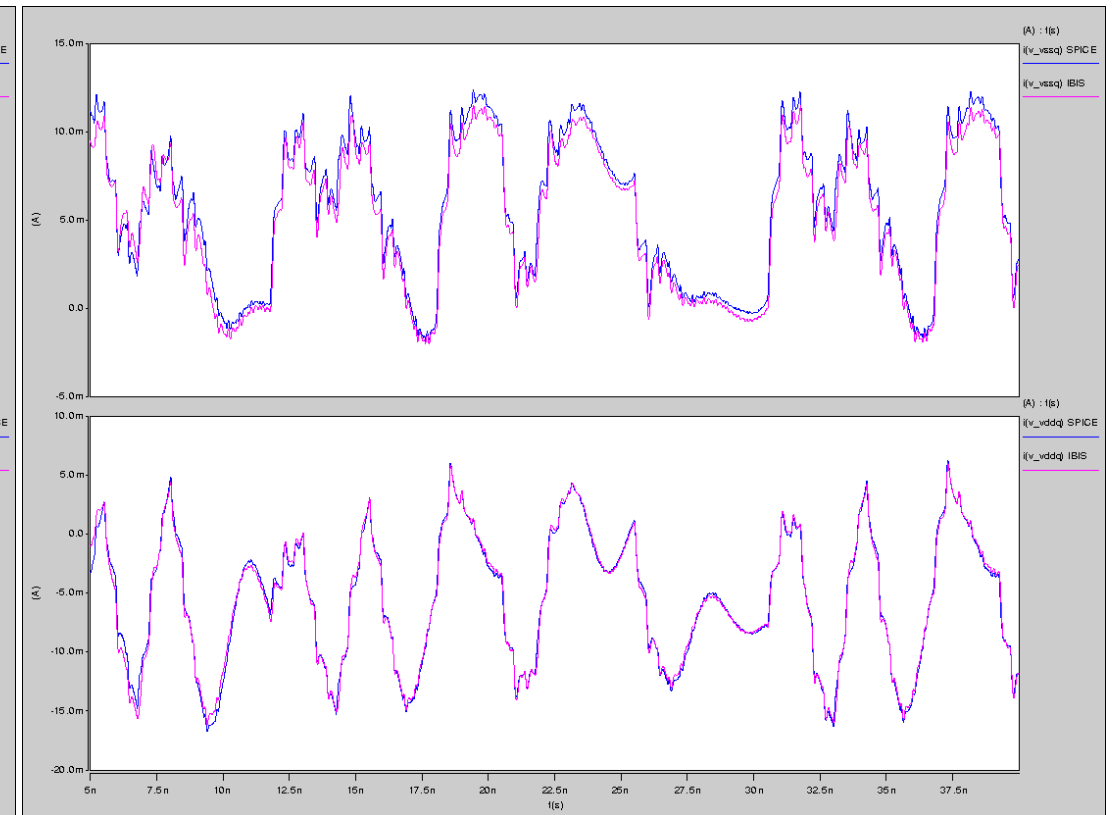


2-Port vs. 3-Port Models, I(VSSQ) and I(VDDQ)

2-Port

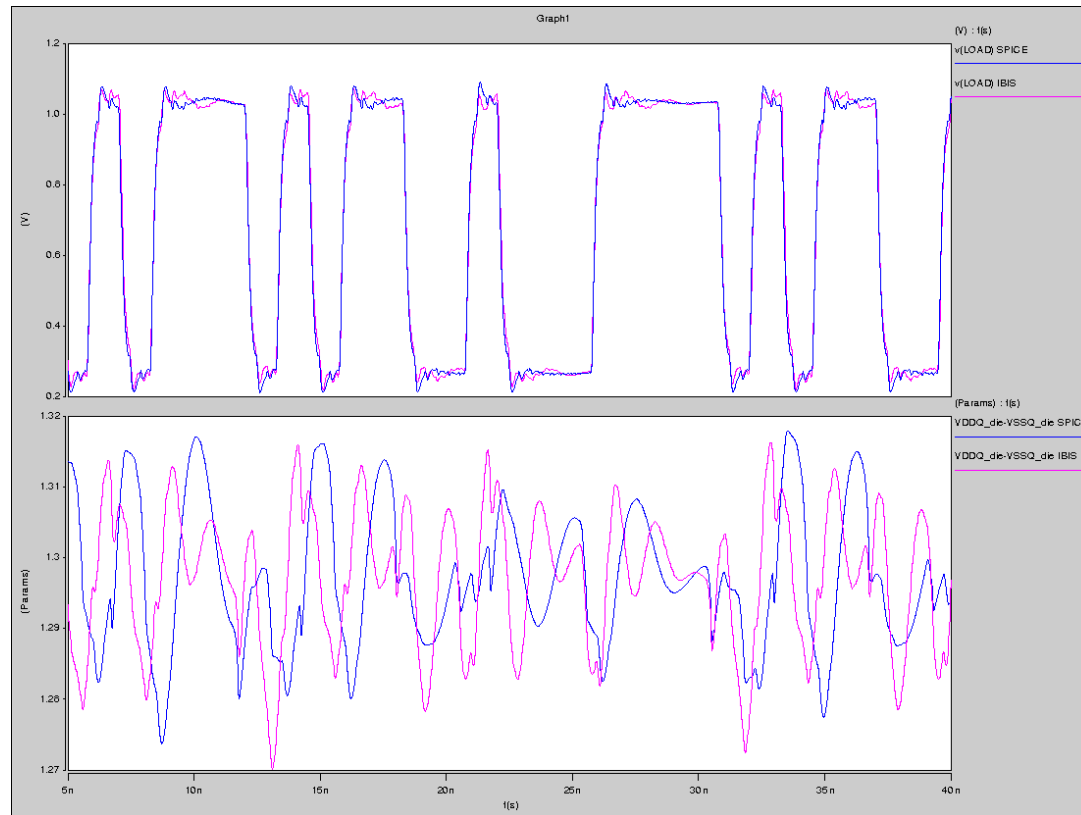


3-Port

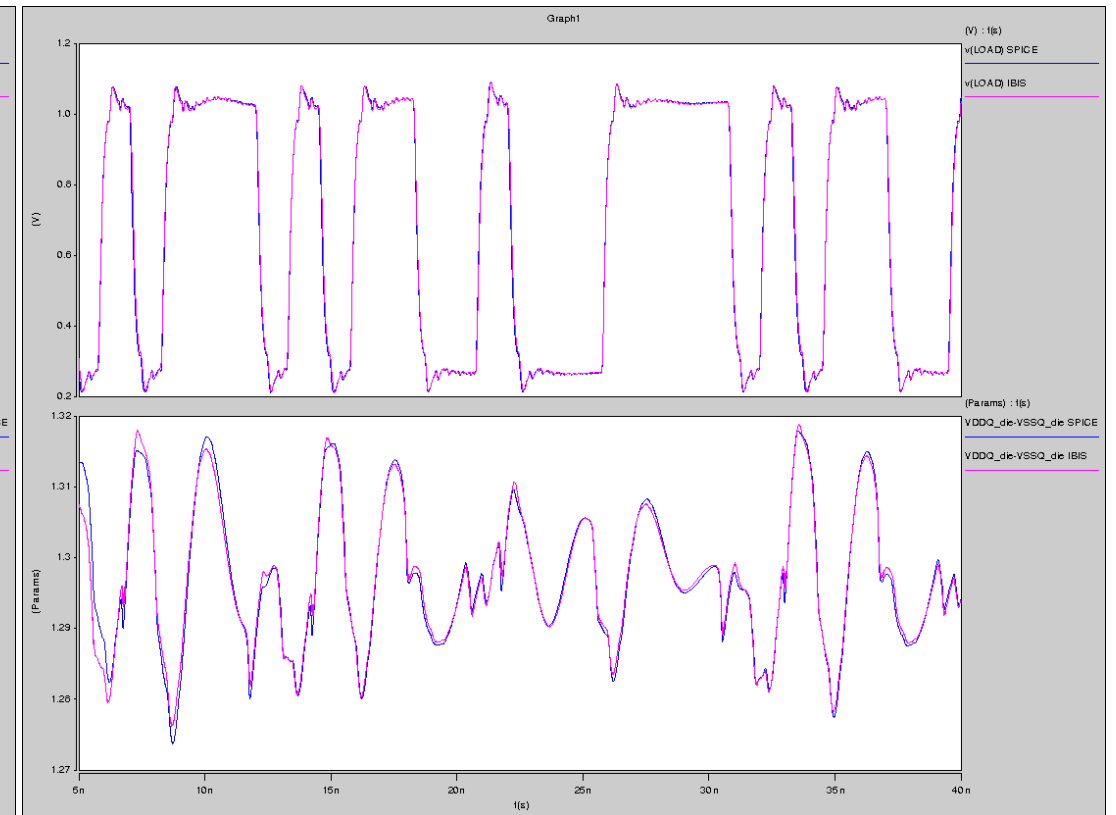


$V(\text{LOAD})$ and $V(\text{VDDQ_die}) - V(\text{VSSQ_die})$

2-Port



3-Port



Conclusions

- A 2-port S-parameter (3-terminal macro-model) for on-die decoupling is a better model than a 1-port model for power-aware simulations.
 - This solution requires use of node 0 in the decoupling model.
- Correlating to a SPICE simulation that includes non-ideal supply connections to pre-driver circuits requires extra ports for non-ideal supplies in the decoupling model.
- A multi-port decoupling model is most versatile. Unused ports not connected to a package model should be connected to 0.
- The new IBIS Interconnect BIRD will allow the IBIS-ISS decoupling model to be connected properly to the package model.

